L Number	Hits	Search Text	DB	Time stamp
7	4260	385/14,43.ccls.	USPAT; US-PGPUB; EPO; JPO	2004/02/18 10:02
8	523	(taper$5 near4 waveguide) and substrate and cladding and core	USPAT; US-PGPUB; EPO; JPO	2004/02/18 10:03
9	148	385/14,43.ccls. and ((taper$5 near4 waveguide) and substrate and cladding and core)	USPAT; US-PGPUB; EPO; JPO	2004/02/18 10:03
-	410	(taper$5 near4 waveguide) and substrate and cladding and core	USPAT; US-PGPUB; EPO; JPO	2004/02/18 10:02
-	46642	385/$6.ccls.	USPAT; US-PGPUB; EPO; JPO	2003/05/12 14:05
-	90	385/129,130,131,132,133.ccls. and ((taper$5 near4 waveguide) and substrate and cladding and core)	USPAT; US-PGPUB; EPO; JPO	2004/02/18 10:02
-	311	385/$6.ccls. and ((taper$5 near4 waveguide) and substrate and cladding and core)	USPAT; US-PGPUB; EPO; JPO	2003/05/13 15:41
-	4405	385/49,50,129,130,131,132,133.ccls.	USPAT; US-PGPUB; EPO; JPO	2003/05/12 14:27
-	138	385/49,50,129,130,131,132,133.ccls. and ((taper$5 near4 waveguide) and substrate and cladding and core)	USPAT; US-PGPUB; EPO; JPO	2003/05/12 14:28
-	489	(taper$5 with waveguide) and substrate and cladding and core	USPAT; US-PGPUB; EPO; JPO	2003/05/12 14:29
-	463	(taper$5 near8 waveguide) and substrate and cladding and core	USPAT; US-PGPUB; EPO; JPO	2003/05/12 17:09
-	199	(taper$5 near8 waveguide) and substrate and cladding and core and etch$4 and mask	USPAT; US-PGPUB; EPO; JPO	2003/05/12 17:10
-	146	385/$6.ccls. and ((taper$5 near8 waveguide) and substrate and cladding and core and etch$4 and mask)	USPAT; US-PGPUB; EPO; JPO	2003/10/29 13:31
-	16	(US-6456766-$ or US-6411757-$ or US-6112002-$ or US-6028973-$ or US-6003222-$ or US-5987046-$ or US-5930433-$ or US-5878070-$ or US-5737474-$ or US-5515464-$ or US-5332690-$ or US-6452726-$).did. or (US-20030044118-$ or US-20030021569-$ or US-20020168166-$ or US-20020141682-$).did.	USPAT; US-PGPUB	2003/05/13 14:24

•	6	((US-6456766-$ or US-6411757-$ or US-6112002-$ or US-6028973-$ or US-6003222-$ or US-5987046-$ or US-5930433-$ or US-5878070-$ or US-5737474-$ or US-5515464-$ or US-5332690-$ or US-6452726-$).did. or (US-20030044118-$ or US-20030021569-$ or US-20020168166-$ or US-20020141682-$).did.) and RIE	USPAT; US-PGPUB; EPO; JPO	2003/05/13 14:25
•	0	((US-6456766-$ or US-6411757-$ or US-6112002-$ or US-6028973-$ or US-6003222-$ or US-5987046-$ or US-5930433-$ or US-5878070-$ or US-5737474-$ or US-5515464-$ or US-5332690-$ or US-6452726-$).did. or (US-20030044118-$ or US-20030021569-$ or US-20020168166-$ or US-20020141682-$).did.) and (RIE near8 lag)	USPAT; US-PGPUB; EPO; JPO	2003/05/13 14:25
•	1007	385/$6.ccls. and (taper$5 near6 waveguide)	USPAT; US-PGPUB; EPO; JPO	2003/05/13 15:45
•	1	5515464.pn.	USPAT; US-PGPUB; EPO; JPO	2003/10/29 13:16
•	410	385/$6.ccls. and ((taper$5 near8 waveguide) and substrate and cladding and core)	USPAT; US-PGPUB; EPO; JPO	2003/10/29 16:34
•	492	385/$6.ccls. and ((taper$5 near8 (waveguide or core)) and substrate and cladding and core)	USPAT; US-PGPUB; EPO; JPO	2003/10/29 16:35
•	215	385/$6.ccls. and ((taper$5 near8 (core)) and substrate and cladding and core)	USPAT; US-PGPUB; EPO; JPO	2003/10/29 16:35
•	1	6624077.pn. and mask	USPAT; US-PGPUB; EPO; JPO	2003/11/12 13:32
•	1	6624077.pn. and (polymer or silica or silicon)	USPAT; US-PGPUB; EPO; JPO	2003/11/12 13:32
•	523	(taper$5 near4 waveguide) and substrate and cladding and core	USPAT; US-PGPUB; EPO; JPO	2004/02/13 11:49
•	1632473	trench or groove or channel or trough	USPAT; US-PGPUB; EPO; JPO	2004/02/13 11:53
•	407	((taper$5 near4 waveguide) and substrate and cladding and core) and (trench or groove or channel or trough)	USPAT; US-PGPUB; EPO; JPO	2004/02/17 11:35
•	1	6112002.pn. and etch$6	USPAT; US-PGPUB; EPO; JPO	2004/02/17 10:53

•	156	((taper$5 near4 waveguide) and substrate and cladding and core) and ((trench or groove or channel or trough) with etch$6)	USPAT; US-PGPUB; EPO; JPO	2004/02/17 11:36
•	0	6624077.URPN.	USPAT	2004/02/17 12:31
•	11	("4426129" | "4578097" | "4709986" | "4896930" | "4904052" | "5263111" | "5333229" | "5366530" | "5465860" | "5770465" | "6097870").PN.	USPAT	2004/02/17 12:31